

1. Record Nr.	UNINA9910830707703321
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Titolo	Applied adhesive bonding [[electronic resource]] : a practical guide for flawless results // Gerd Habenicht ; translated by Christine Ahner
Pubbl/distr/stampa	Weinheim ; ; Chichester, : Wiley-VCH, c2009
ISBN	1-282-02166-4 9786612021664 3-527-62645-X 3-527-62646-8
Descrizione fisica	1 online resource (188 p.)
Altri autori (Persone)	AhnerChristine
Disciplina	668.3
Soggetti	Adhesives Binders (Materials)
Lingua di pubblicazione	Inglese
Formato	Materiale a stampa
Livello bibliografico	Monografia
Note generali	Includes bibliographical references (p. 145-147) and index.
Nota di contenuto	Applied Adhesive Bonding; Contents; Preface; 1 Introduction; 1.1 Bonding as a Joining Process; 1.2 Advantages and Disadvantages of Bonding; 1.3 Terms and Definitions; 2 Structure and Classification of Adhesives; 2.1 Structure of Adhesives; 2.1.1 Carbon as Central Element; 2.1.2 Monomer - Polymer; 2.1.3 Polymer Formation; 2.2 Classification of Adhesives; 2.2.1 Adhesives Curing by Chemical Reaction (Reactive Adhesives); 2.2.2 Adhesives Curing without Chemical Reaction (Physically Setting Adhesives); 2.2.3 Solvent-Containing and Solvent-Free Adhesives 2.2.4 Adhesives on Natural and Synthetic Basis 2.2.5 Adhesives on Organic and Inorganic Basis; 2.2.6 Application-Related Names of Adhesives; 3 From Adhesive to Adhesive Layer; 3.1 Reactive Adhesives - Fundamentals; 3.1.1 Pot Life; 3.1.2 Mixing Ratio of the Components; 3.1.3 Impact of Time on Adhesive Curing; 3.1.4 Impact of Temperature on Adhesive Curing; 3.2 Two-Component and One-Component Reactive Adhesives; 3.2.1 Two-Component Reactive Adhesives; 3.2.2 One-Component Reactive Adhesives; 3.3 Properties of Adhesive Layers; 3.3.1 Thermoplastics; 3.3.2 Thermoset Plastics; 3.3.3 Elastomers 3.3.4 Glass Transition Temperature 3.3.5 Creep; 4 Important Reactive

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Sommario/riassunto

This manual provides the most important information on successful bonding. Various practical advices and helpful tips are useful for the handling of adhesives. Due to its didactically structured content, the book may also serve as a medium for training courses in bonding engineering. The basics of this innovative joining procedure are described in a practical and easily understandable way suitable for the application in trade and industry.
